

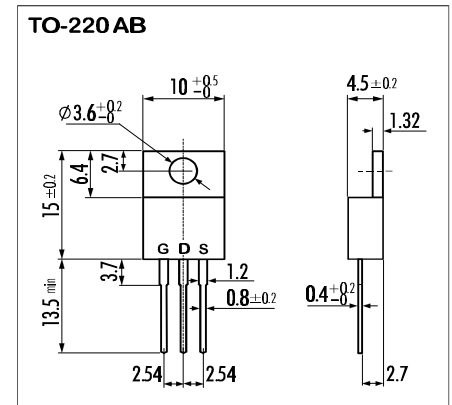
### > Features

- High Current
- Low On-Resistance
- No Secondary Breakdown
- Low Driving Power
- Avalanche Rated

### > Applications

- Motor Control
- General Purpose Power Amplifier
- DC-DC converters

### > Outline Drawing

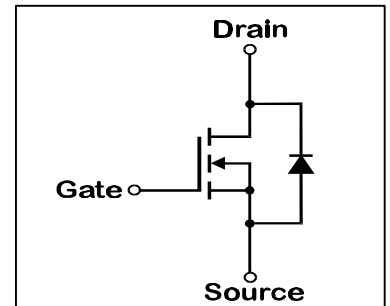


### > Maximum Ratings and Characteristics

- Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$ ), unless otherwise specified

| Item                                    | Symbol        | Rating     | Unit |
|-----------------------------------------|---------------|------------|------|
| Drain-Source-Voltage                    | $V_{DS}$      | 60         | V    |
| Continuous Drain Current                | $I_D$         | ±45        | A    |
| Pulsed Drain Current                    | $I_{D(puls)}$ | ±180       | A    |
| Gate-Source-Voltage                     | $V_{GS}$      | ±30        | V    |
| Maximum Avalanche Energy                | $E_{AV}$      | 461.9      | mJ*  |
| Max. Power Dissipation                  | $P_D$         | 60         | W    |
| Operating and Storage Temperature Range | $T_{ch}$      | 150        | °C   |
|                                         | $T_{stg}$     | -55 ~ +150 | °C   |

\*  $L=0.304\text{mH}$ ,  $V_{CC}=24\text{V}$



- Electrical Characteristics ( $T_C=25^\circ\text{C}$ ), unless otherwise specified

| Item                                                 | Symbol       | Test conditions                                                                                   | Min. | Typ. | Max. | Unit |
|------------------------------------------------------|--------------|---------------------------------------------------------------------------------------------------|------|------|------|------|
| Drain-Source Breakdown-Voltage                       | $BV_{DSS}$   | $I_D=1\text{mA}$ $V_{GS}=0\text{V}$                                                               | 60   |      |      | V    |
| Gate Threshold Voltage                               | $V_{GS(th)}$ | $I_D=10\text{mA}$ $V_{DS}=V_{GS}$                                                                 | 2,5  | 3    | 3,5  | V    |
| Zero Gate Voltage Drain Current                      | $I_{DSS}$    | $V_{DS}=60\text{V}$ $T_{ch}=25^\circ\text{C}$                                                     |      | 10   | 500  | μA   |
|                                                      |              | $V_{GS}=0\text{V}$ $T_{ch}=125^\circ\text{C}$                                                     |      | 0,2  | 1,0  | mA   |
| Gate Source Leakage Current                          | $I_{GSS}$    | $V_{GS}=30\text{V}$ $V_{DS}=0\text{V}$                                                            |      | 10   | 100  | nA   |
| Drain Source On-State Resistance                     | $R_{DS(on)}$ | $I_D=22.5\text{A}$ $V_{GS}=10\text{V}$                                                            |      | 12,0 | 14,5 | mΩ   |
| Forward Transconductance                             | $g_{fs}$     | $I_D=22.5\text{A}$ $V_{DS}=25\text{V}$                                                            | 10   | 25   |      | S    |
| Input Capacitance                                    | $C_{iss}$    | $V_{DS}=25\text{V}$                                                                               |      | 2300 | 3450 | pF   |
| Output Capacitance                                   | $C_{oss}$    | $V_{GS}=0\text{V}$                                                                                |      | 910  | 1370 | pF   |
| Reverse Transfer Capacitance                         | $C_{rss}$    | $f=1\text{MHz}$                                                                                   |      | 260  | 390  | pF   |
| Turn-On-Time $t_{on}$ ( $t_{on}=t_{d(on)}+t_r$ )     | $t_{d(on)}$  | $V_{CC}=30\text{V}$<br>$V_{GS}=10\text{V}$<br>$I_D=45\text{A}$<br>$R_{GS}=10\Omega$               |      | 18   | 30   | ns   |
|                                                      | $t_r$        |                                                                                                   |      | 55   | 80   | ns   |
| Turn-Off-Time $t_{off}$ ( $t_{off}=t_{d(off)}+t_f$ ) | $t_{d(off)}$ |                                                                                                   |      | 70   | 120  | ns   |
|                                                      | $t_f$        |                                                                                                   |      | 48   | 80   | ns   |
| Avalanche Capability                                 | $I_{AV}$     | $L=100\mu\text{H}$ $T_{ch}=25^\circ\text{C}$                                                      | 45   |      |      | A    |
| Diode Forward On-Voltage                             | $V_{SD}$     | $I_F=45\text{A}$ $V_{GS}=0\text{V}$ $T_{ch}=25^\circ\text{C}$                                     |      | 1,0  | 1,5  | V    |
| Reverse Recovery Time                                | $t_{rr}$     | $I_F=45\text{A}$ $V_{GS}=0\text{V}$<br>$-di/dt=100\text{A}/\mu\text{s}$ $T_{ch}=25^\circ\text{C}$ |      | 60   |      | ns   |
| Reverse Recovery Charge                              | $Q_{rr}$     |                                                                                                   |      | 0,11 |      | μC   |

- Thermal Characteristics

| Item               | Symbol         | Min. | Typ. | Max.  | Unit |
|--------------------|----------------|------|------|-------|------|
| Thermal Resistance | $R_{th(ch-c)}$ |      |      | 2,08  | °C/W |
|                    | $R_{th(ch-a)}$ |      |      | 75,00 | °C/W |

| N-channel MOS-FET |        |      |     |
|-------------------|--------|------|-----|
| 60V               | 14,5mΩ | ±45A | 60W |

# 2SK2900-01

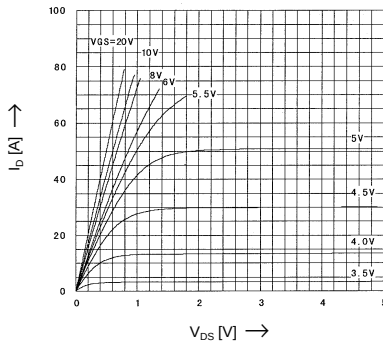
## FAP-III B Series

**FUJI**  
ELECTRIC

### > Characteristics

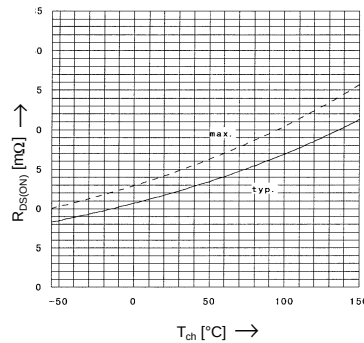
Typical Output Characteristics

$I_D = f(V_{DS})$ ; 80μs pulse test;  $T_C = 25^\circ\text{C}$



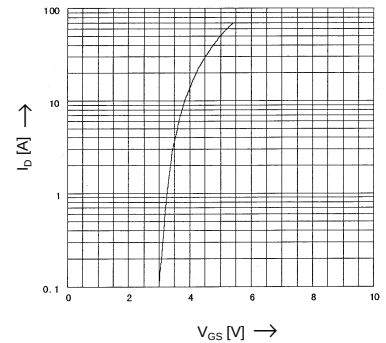
Drain-Source On-State Resistance vs.  $T_{ch}$

$R_{DS(on)} = f(T_{ch})$ ;  $I_D = 22.5\text{A}$ ;  $V_{GS} = 10\text{V}$



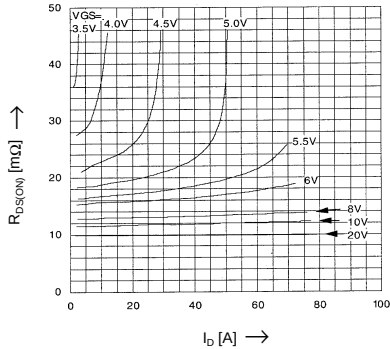
Typical Transfer Characteristics

$I_D = f(V_{GS})$ ; 80μs pulse test;  $V_{DS} = 25\text{V}$ ;  $T_C = 25^\circ\text{C}$



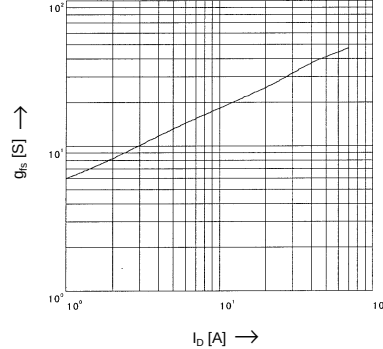
Typical Drain-Source On-State-Resistance vs.  $I_D$

$R_{DS(on)} = f(I_D)$ ; 80μs pulse test;  $T_C = 25^\circ\text{C}$



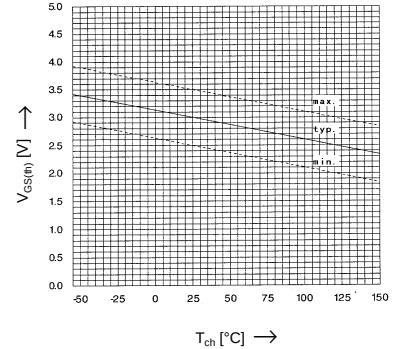
Typical Forward Transconductance vs.  $I_D$

$g_{fs} = f(I_D)$ ; 80μs pulse test;  $V_{DS} = 25\text{V}$ ;  $T_C = 25^\circ\text{C}$



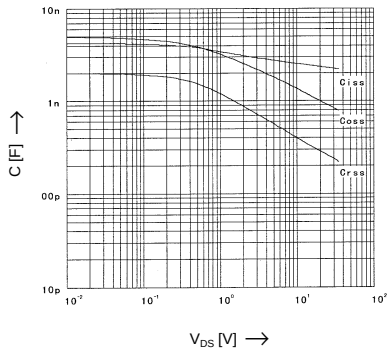
Gate Threshold Voltage vs.  $T_{ch}$

$V_{GS(th)} = f(T_{ch})$ ;  $I_D = 10\text{mA}$ ;  $V_{DS} = V_{GS}$



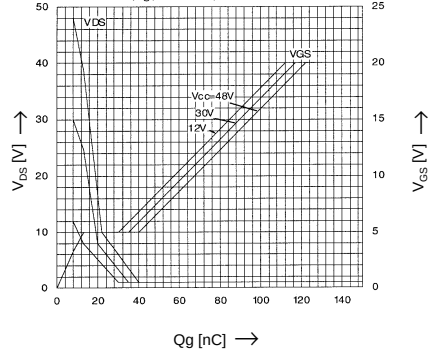
Typical Capacitances vs.  $V_{DS}$

$C = f(V_{DS})$ ;  $V_{GS} = 0\text{V}$ ;  $f = 1\text{MHz}$



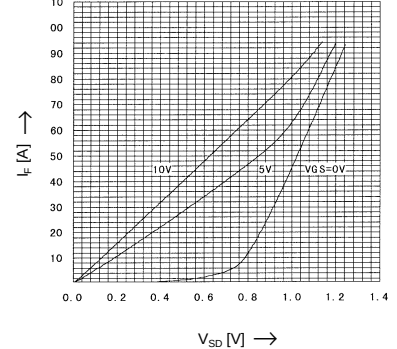
Typical Gate Charge Characteristic

$V_{GS} = f(Q_g)$ ;  $I_D = 45\text{A}$ ;  $T_C = 25^\circ\text{C}$



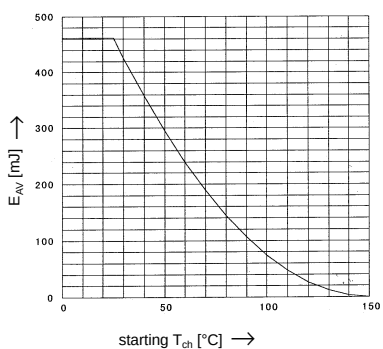
Forward Characteristics of Reverse Diode

$I_F = f(V_{SD})$ ; 80μs pulse test;  $T_C = 25^\circ\text{C}$



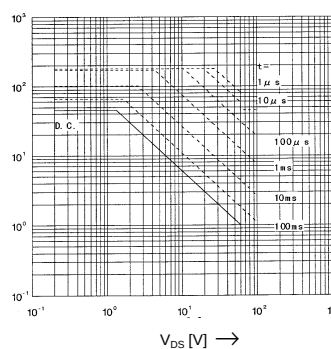
Maximum Avalanche Energy vs. starting  $T_{ch}$

$E_{AV} = f(\text{starting } T_{ch})$ ;  $V_{CC} = 24\text{V}$ ;  $I_{AV} \leq 45\text{A}$



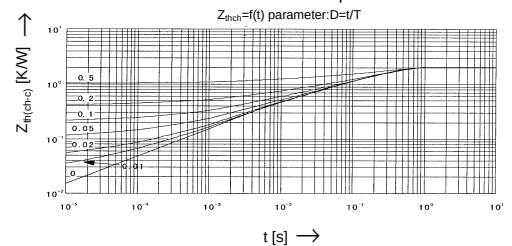
Safe Operation Area

$I_D = f(V_{DS})$ ;  $D = 0.01$ ;  $T_C = 25^\circ\text{C}$



Transient Thermal impedance

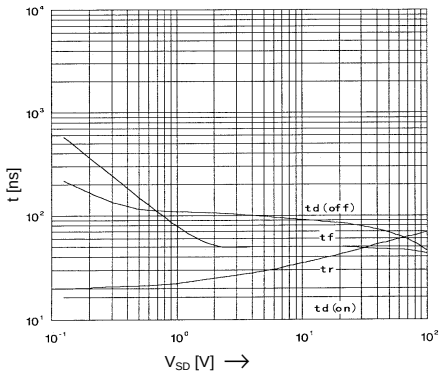
$Z_{th(ch-c)} = f(t)$  parameter:  $D = t/T$



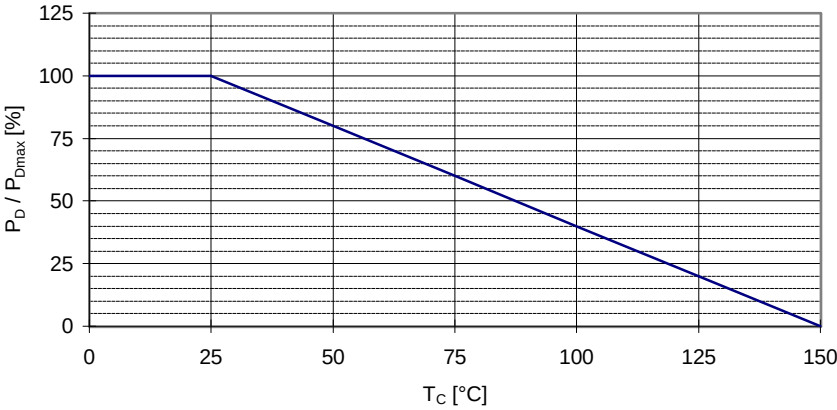
| N-channel MOS-FET |        |      |     |
|-------------------|--------|------|-----|
| 60V               | 14,5mΩ | ±45A | 60W |

> Characteristics

Typical Switching Characteristics  
t=(t<sub>b</sub>): V<sub>CC</sub> = 30V, V<sub>GS</sub> = 10V, R<sub>G</sub> = 10Ω



Power Dissipation  
 $P_D=f(T_C)$



Maximum Avalanche Current vs. starting T<sub>ch</sub>  
 $I_{AV}=f(\text{starting } T_{ch})$

